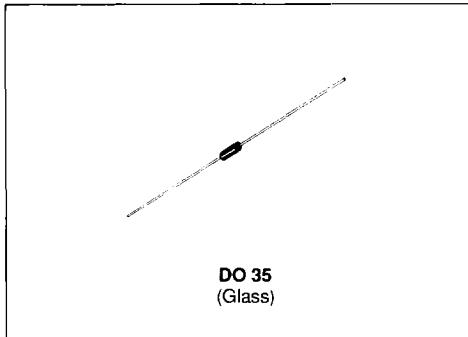


TEMPERATURE COMPENSATED ZENER DIODES

NEW SERIE

- SEMICONDUCTOR MATERIAL : SILICON
- TECHNOLOGY : LOCAL EPITAXY + GUARD RING


ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
P _{tot}	Power Dissipation*	0.4	W
T _{stg} T _j	Storage and Junction Temperature Range	- 65 to 175 - 65 to 175	°C °C
T _L	Maximum Lead Temperature for Soldering during 10s at 4mm from Case	230	°C

THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
R _{th (j-a)}	Junction to Ambient*	300	°C/W

ELECTRICAL CHARACTERISTICS (T_{amb} = 25°C unless otherwise specified)

Types	V _{ZT} typ. (V)	R _{ZT} @ I _{ZT} max. (Ω)	I _{ZT} (mA)	Test Temperatures				ΔV _Z * max. (mV)	αV _Z (10 ⁻⁶ /°C)
				(°C)					
1N 4775	8.5	200	0.5	0	+ 25	+ 75		64	100
1N 4776	8.5	200	0.5	0	+ 25	+ 75		32	50
1N 4777	8.5	200	0.5	0	+ 25	+ 75		13	20
1N 4778	8.5	200	0.5	0	+ 25	+ 75		6	10
1N 4779	8.5	200	0.5	0	+ 25	+ 75		3	5
1N 4775 A	8.5	200	0.5	- 55	0	+ 25	+ 75	+ 100	132
1N 4776 A	8.5	200	0.5	- 55	0	+ 25	+ 75	+ 100	66
1N 4777 A	8.5	200	0.5	- 55	0	+ 25	+ 75	+ 100	26
1N 4778 A	8.5	200	0.5	- 55	0	+ 25	+ 75	+ 100	13
1N 4779 A	8.5	200	0.5	- 55	0	+ 25	+ 75	+ 100	7

* On infinite heatsink with d = 4mm.

 ** The voltage reference diodes are characterized by the box method. The maximum allowable voltage change ΔV_Z is guaranteed any two temperature within the range. Tests are performed at the indicated temperatures and the specified current.

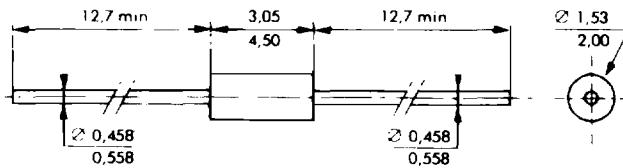
ELECTRICAL CHARACTERISTICS (continued)

Types	V _{ZT} typ. (V)	R _{ZT} @ I _{ZT} max. (Ω)	I _{ZT} (mA)	Test Temperatures			ΔV _Z ** max. (mV)	αV _Z (10 ⁻⁶ /°C)
				(°C)				
1N 4780	8.5	100	1	0	+ 25	+ 75	64	100
1N 4781	8.5	100	1	0	+ 25	+ 75	32	50
1N 4782	8.5	100	1	0	+ 25	+ 75	13	20
1N 4783	8.5	100	1	0	+ 25	+ 75	6	10
1N 4784	8.5	100	1	0	+ 25	+ 75	3	5
1N 4780 A	8.5	100	1	- 55	0	+ 25	+ 75	+ 100
1N 4781 A	8.5	100	1	- 55	0	+ 25	+ 75	+ 100
1N 4782 A	8.5	100	1	- 55	0	+ 25	+ 75	+ 100
1N 4783 A	8.5	100	1	- 55	0	+ 25	+ 75	+ 100
1N 4784 A	8.5	100	1	- 55	0	+ 25	+ 75	+ 100

* The voltage reference diodes are characterized by the box method. The maximum allowable voltage change ΔV_Z is guaranteed any two temperature within the range.

PACKAGE MECHANICAL DATA

DO 35 Glass



Cooling method : by convection and conduction.

Marking : clear, ring at cathode end.

Weight : 0.15g

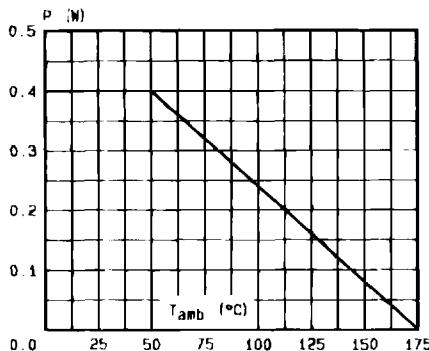


Fig.1 - Power dissipation versus ambient temperature.

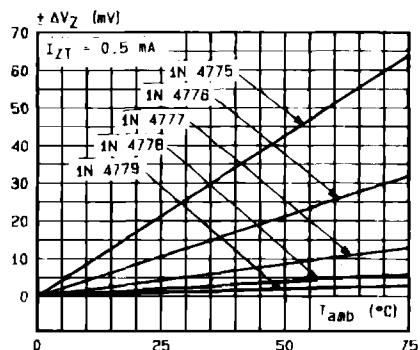


Fig.2a - Regulation voltage variation versus ambient temperature.

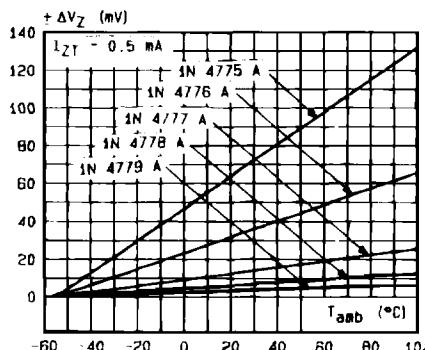


Fig.2b - Regulation voltage variation versus ambient temperature.

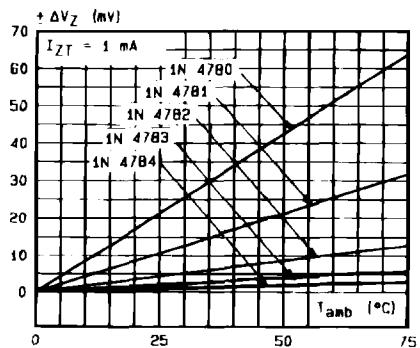


Fig.2c - Regulation voltage variation versus ambient temperature.

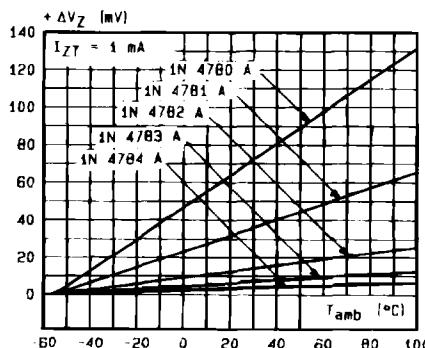


Fig.2d - Regulation voltage variation versus ambient temperature.